



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



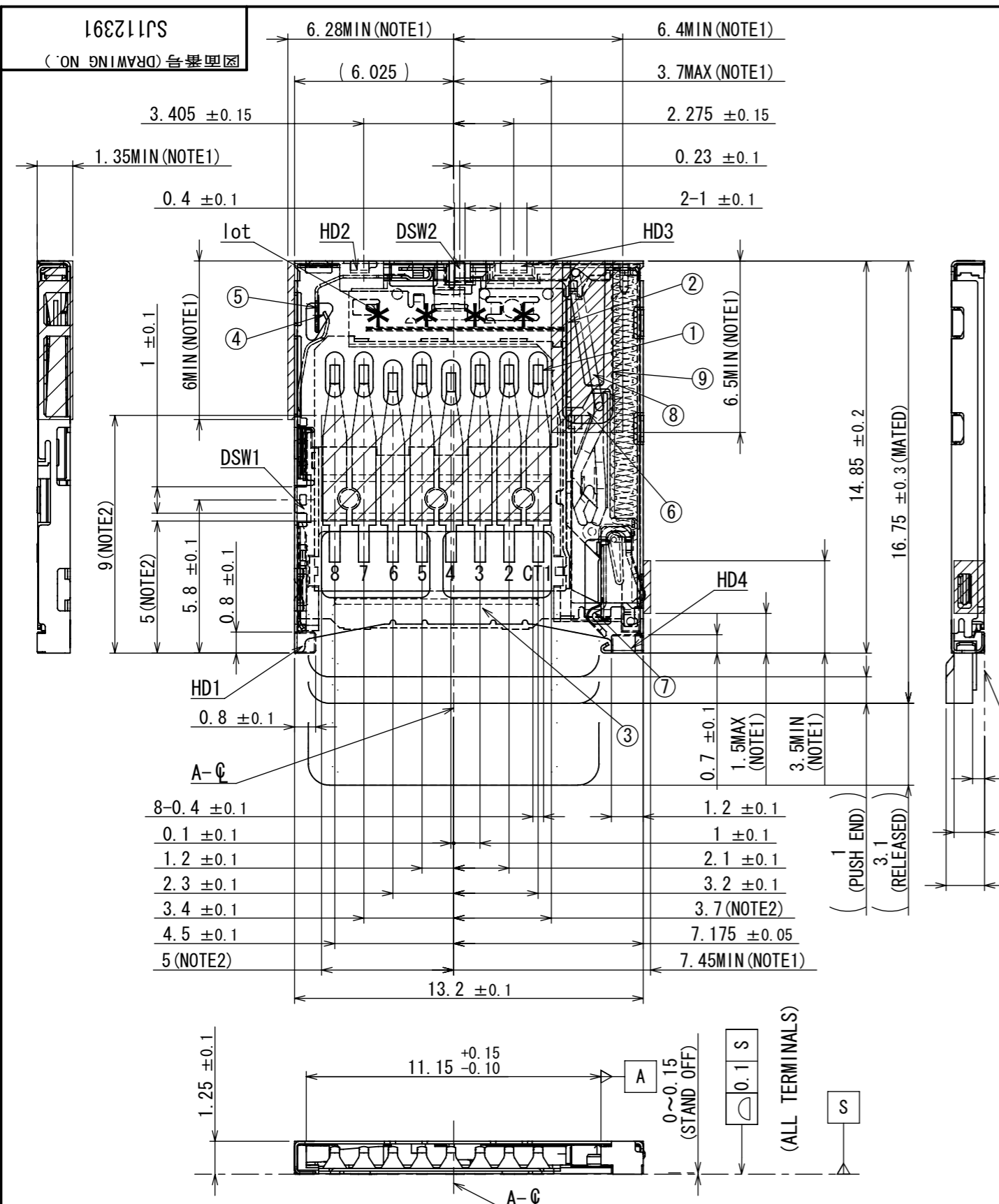
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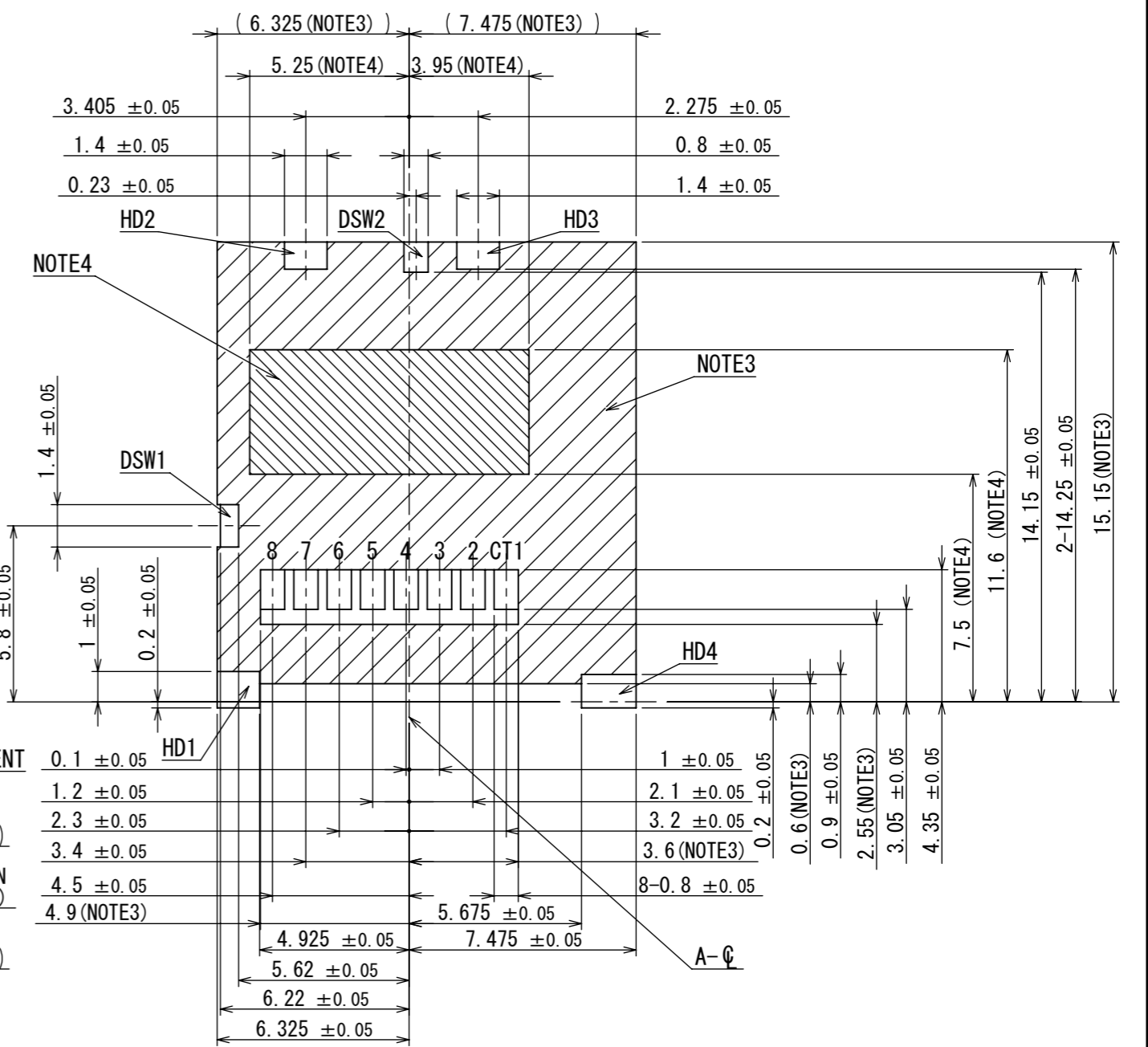
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版数 REV.	年月日 DATE	CN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
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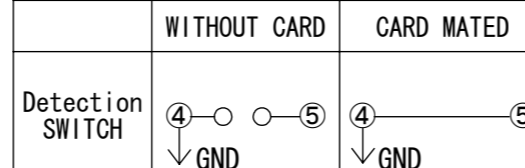


符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
9	SPRING	1	STAINLESS	-	
8	CAM FOLLOEW	1	STAINLESS	-	
7	LOCK	1	STAINLESS	-	
6	EJECT LEVER	1	GLASS FILLED 9TNy	-	
5	DETECTION SWITCH2	1	COPPER ALLOY	CONTACTING AREA: GOLD(0.3~1.0μm) OVER NICKEL TERMINAL AREA: GOLD(0.03~0.1μm) FLASH OVER NICKEL	
4	DETECTION SWITCH1	1	COPPER ALLOY	CONTACTING AREA: GOLD(0.3~1.0μm) OVER NICKEL TERMINAL AREA: GOLD(0.03~0.1μm) FLASH OVER NICKEL	
3	COVER FRAME (HOLD DOWN)	1	STAINLESS	TERMINAL AREA: GOLD(0.03~0.1μm) FLASH OVER NICKEL	
2	HOUSING	1	GLASS FILLED LCP	-	
1	CONTACT	8	COPPER ALLOY	CONTACTING AREA: GOLD(0.5~1.0μm) OVER NICKEL TERMINAL AREA: GOLD(0.03~0.1μm) FLASH OVER NICKEL	

NOTE1. THERE IS NO APPLY THE LOAD ON THIS AREA BY THE CASE.
 NOTE2. VACUUM AREA.
 NOTE3. ONLY GND PATTERN AND GND VIA HOLE IN ALLOWED IN THIS AREA
 NOTE4. NO PATTERN, VIA HOLE IN THIS AREA
 NOTE5. PB FREE, HALOGEN FREE

注1. 本面に筐体と接触しないようにしてください。
 注2. 吸着エリア
 注3. 底面部が金属(GND)につき、GNDパターン及びGNDビアのみ可とする。
 注4. コンタクト可動部につき、パターン及びビアを禁止する
 注5. PBフリー、ハロゲンフリー

Table.1 CIRCUIT



仕様書(SPECIFICATION)		第1版(ORIGINAL DATE)		尺度(SCALE)		シリーズ(SERIES)	
JACS-10634* JAHL-10634*		27/DEC/2011		5 : 1		ST10	
SJ112392		製図 DR.		名称(TITLE)		日本航空電子工業株式会社	
一般公差(GENERAL TOLERANCE)		担当 CHK.		ST10S008V4B		JAPAN AVIATION ELECTRONICS INDUSTRY,LTD.	
寸法(DIMENSION)		査閲 APPD.		質量(MASS)		図面番号(DRAWING NO.)	
. ±0.8		Y. SATOU		⊕		SJ112391	
× ±0.4		承認 APPD.		⊖		版数(REV.)	
×× ±0.1		A. NATORI		⊕		1	
××× ±				⊖			

DCF-C-2126 (11.08)

WISDOM承認 2011/12/27

SIZE A3